

FCH25N60N N-Channel MOSFET 600V, 25A, 0.126Ω

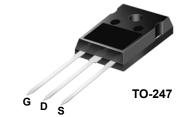
Features

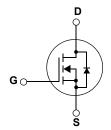
- + $R_{DS(on)}$ = 0.108 Ω (Typ.) at V_{GS} = 10V, I_D = 12.5A
- Ultra Low Gate Charge (Typ. Qg = 57nC)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- RoHS Compliant

Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

This SupreMOS MOSF ET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter			FCH25N60N	Units	
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Gate to Source Voltage		±30	V		
ID	Drain Current	Continuous ($T_C = 25^{\circ}C$)		25		
		Continuous ($T_c = 100^{\circ}C$)		16	A	
I _{DM}	Drain Current	Pulsed	(Note 1)	75	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			861	mJ	
I _{AR}	Avalanche Current			8.3	А	
E _{AR}	Repetitive Avalanche Energy		2.2	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)			20	V/ns	
	MOSFET dv/dt			100		
P _D	Dower Dissinction	(T _C = 25°C)		216	W	
	Power Dissipation	Derate above 25°C		1.72	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCH25N60N	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.58	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.24	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	40	

January 2011

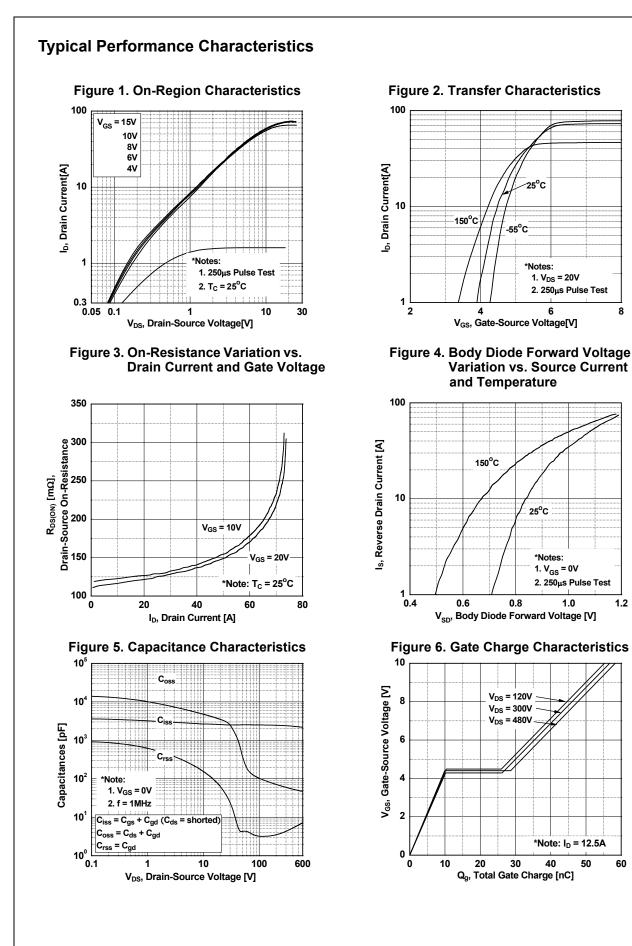
SupreMOS®

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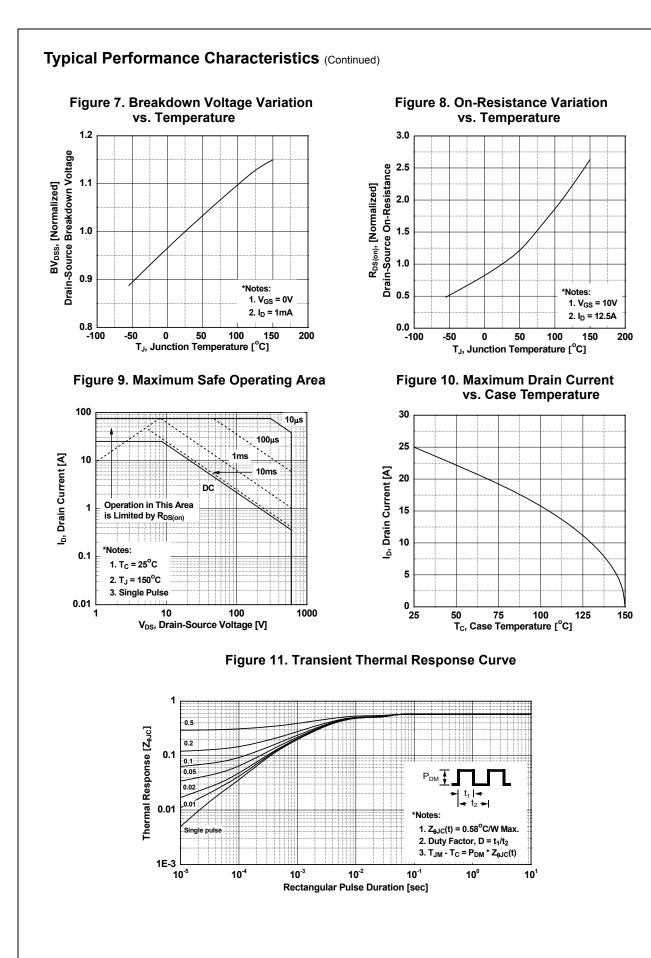
	arking	Device	Package	е	Reel Size	Тар	e Width		Quantit	у
FCH25N			TO247		-	· ·	-		30	
=loctrica	l Char	acteristics		I		_1				
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Charac	toristic	e						71		
BV _{DSS}		Source Breakdown V	oltage	l_ = 1m	$A_{V_{00}} = 0VT_{1} = 2^{4}$	5°C	600	_	-	V
∆BV _{DSS}		Breakdown Voltage Temperature		$I_{\rm D} = 1$ mA, $V_{\rm GS} = 0$ V, $T_{\rm J} = 25^{\circ}$ C		000				
ΔT_{J}	Coefficient		$I_D = 1$ mA, Referenced to 25°C		-	0.74	-	V/ºC		
I	Zero Ga	ero Gate Voltage Drain Current			80V, V _{GS} = 0V		-	-	10	
DSS	2610 08			V _{DS} = 480V, T _J = 125°C			-	-	100	μΑ
GSS	Gate to Body Leakage Current		ıt	V _{GS} = =	±30V, V _{DS} = 0V		-	-	±100	nA
On Charac	teristic	s								
V _{GS(th)}		nreshold Voltage		V _{GS} = V _{DS} , I _D = 250μA		2.0	_	4.0	V	
R _{DS(on)}		rain to Source On Res	sistance		$10V, I_D = 12.5A$		-	0.108	0.126	Ω
9FS		d Transconductance	<i>Notarioe</i>		20V, I _D = 12.5A		-	0.100	-	S
				- 03						-
Dynamic C	characte	ristics								
C _{iss}	Input Ca	apacitance		V _			-	2520	3352	pF
C _{oss}	Output	Output Capacitance Reverse Transfer Capacitance Output Capacitance ffective Output Capacitance		— V _{DS} = 100V, V _{GS} = 0V f = 1MHz		-	103	137	pF	
C _{rss}	Reverse					-	3.2	5	pF	
C _{oss}	Output			V_{DS} = 380V, V_{GS} = 0V, f = 1MHz			-	55	-	pF
C _{oss} eff.	Effective			V_{DS} = 0V to 480V, V_{GS} = 0V		-	262	-	pF	
Q _{g(tot)}	Total Ga	ate Charge at 10V				-	57	74	nC	
Q _{gs}	Gate to	Gate to Source Gate Charge Gate to Drain "Miller" Charge Equivalent Series Resistance (G-S)		$V_{DS} = 380V, I_D = 12.5A,$		-	10	-	nC	
Q _{gd}	Gate to			V _{GS} = 10V (Note 4)			-	18	-	nC
ESR	Equival			Drain Open, f=1MHz			-	1	-	Ω
Switching	Charac	teristics								
t _{d(on)}	1	Delay Time					-	21	52	ns
<u>ଏ(on)</u> t _r		Turn-On Rise Time		V _{DD} = 380V, I _D = 12.5A		_	22	54	ns	
t _{d(off)}				$R_{G} = 4.7\Omega$			-	68	146	ns
t _f		f Fall Time		-	(Note 4)		-	5	20	ns
		de Characteristic				, ,				
I _s	-,	m Continuous Drain to		Forwar	d Current		-	-	25	Α
5		m Pulsed Drain to Sou					-	-	75	A
		Source Diode Forward		$V_{GS} = 0V, I_{SD} = 12.5A$		-	-	1.2	V	
I _{SM} Vsd			<u> </u>	$V_{GS} = 0V, I_{SD} = 12.5A$ $V_{GS} = 0V, I_{SD} = 12.5A$			-	370	-	ns
I _{SM} V _{SD} t _{rr}		Recovery Time								

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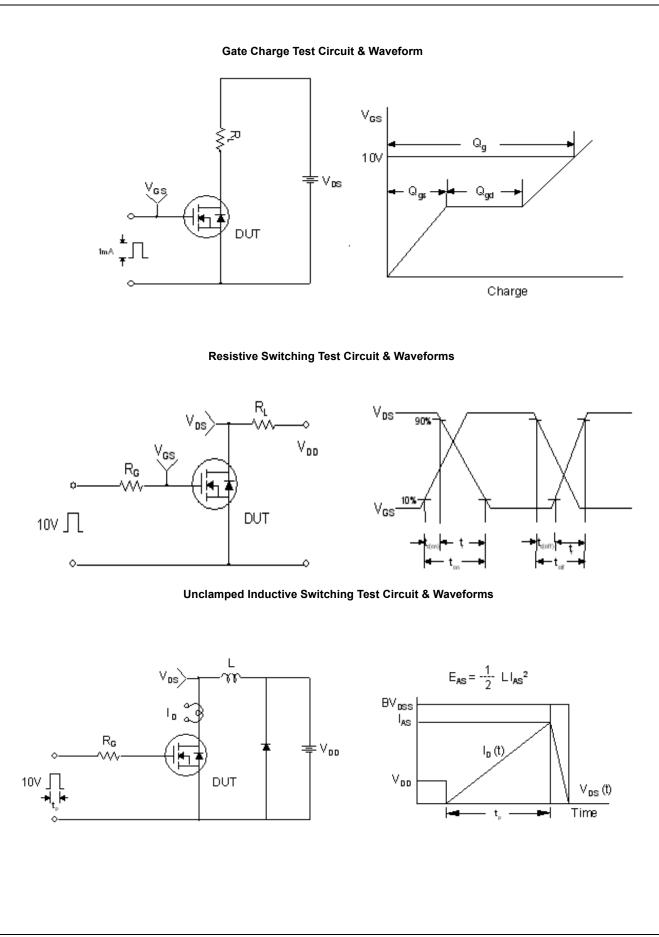
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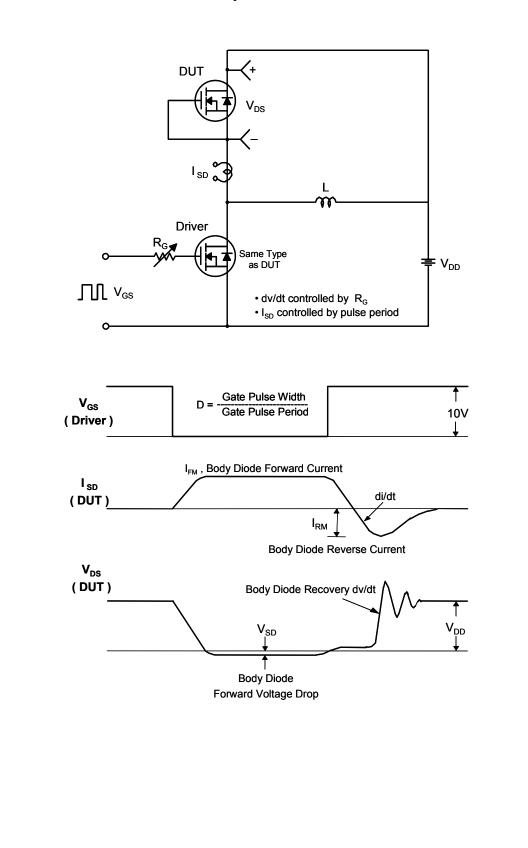


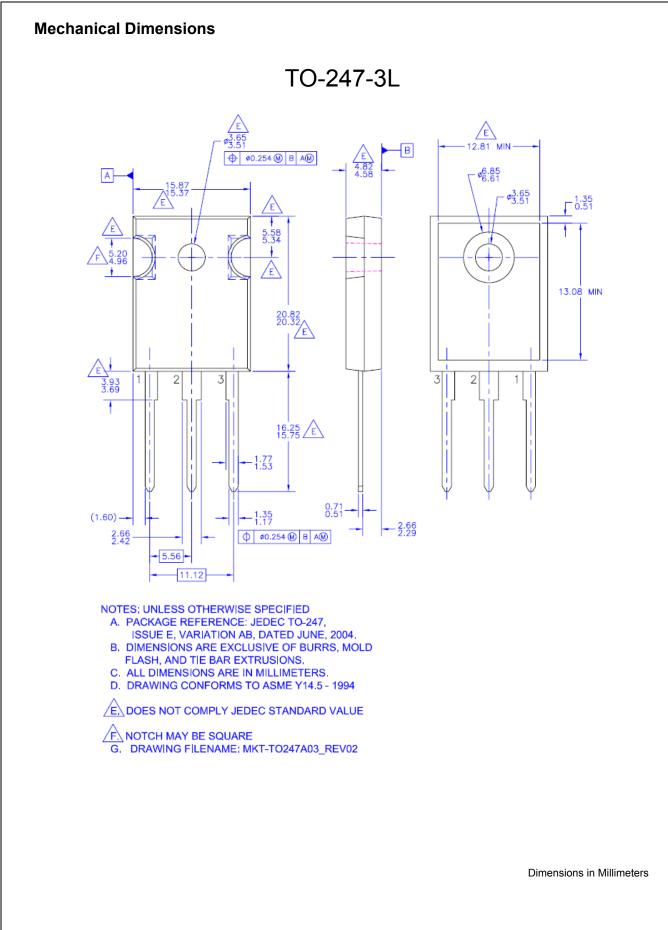
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